

Attorney Docket No.: 42390P760

Serial no 09 471 220  
A 2123

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

LLOYD L. POLLARD, II, ET AL.

For: **Dynamic Thermal Management For  
Integrated Circuits**

#5 / Re Amendment A  
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Assistant Commissioner for Patents  
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on 2-4-03  
Date of Deposit  
Carla Vignola  
Name of Person Mailing Correspondence  
Signature  
2-4-03  
Date

**PRELIMINARY AMENDMENT**

Dear Sir:

Please enter the following preliminary amendment for the present patent application.

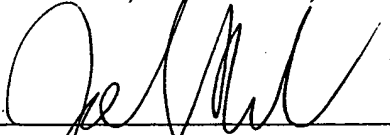
**IN THE SPECIFICATION:**

Please amend the title of the specification as follows:

On the cover page of the specification, please delete, [DYNAMIC CONFIGURABLE THERMAL MANAGEMENT] and insert --DYNAMIC THERMAL MANAGEMENT FOR INTEGRATED CIRCUITS--

Respectfully submitted,

BLAKELY, SOKOLOFF, TAYLOR & ZAFM

  
John P. Ward, Reg. No. 40,216

Dated: 2/4/03

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